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1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Valu	Unit	
Symbol	Farameter	TO-220	TO-220FP	Offic
V _{GS}	Gate-source voltage	0	٧	
I _D	Drain current (continuous) at T _C = 25°C	8 ⁽¹⁾	Α	
I _D	Drain current (continuous) at T _C = 100°C	5	5 (1)	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	32	32 ⁽¹⁾	Α
P _{TOT}	Total dissipation at T _C = 25°C	100	25	W
	Derating factor	0.8	W/°C	
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15	<i>y</i>	V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1s;TC=25°C) 2500			
T _j T _{stg}	Operating junction temperature Storage temperature	-65 to	150	°C

- 1. Limited only by maximum temperature allowed
- 2. Pulse width limited by safe operating area
- 3. $I_{SD} \le 8 \text{ A, di/dt} \le 200 \text{ A/}\mu\text{s, V}_{DD} \le V_{(BR)DSS}, T_j \le T_{JMAX}$.

Table 2. Thermal data

Symbol	Parameter	TO-220	TO-220FP	Unit
Rthj-case	Thermal resistance junction-case max	1.25	5	°C/W
Rthj-amb	Thermal resistance junction-amb max	62.5		°C/W
∠ T _i	Maximum lead temperature for soldering purpose	300		°C

Table 3. Avalanche characteristics

Symbol	Parameter	Max value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj max)	2.5	Α
E _{AS}	Single pulse avalanche energy (starting Tj=25°C, I _D =I _{AR} , V _{DD} = 50V)	200	mJ

2 **Electrical characteristics**

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250\mu A, V_{GS} = 0$	500			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating, V _{DS} = Max rating @125°C			1 10 -	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ±30 V		. (±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	٧
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 2.5A	070	0.7	0.8	Ω
		3/2				
Table 5.	Dynamic	76,				
	5			_		

Table 5. **Dynamic**

	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_{D} = 2.5A$		2.4		S
	C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25V, f=1 MHz, V _{GS} =0		415 88 12		pF pF pF
	C _{oss eq.} (2) Equiv		V _{GS} =0, V _{DS} =0V to 400V		50		pF
9/6	$egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =400V, I_{D} = 5A V_{GS} =10V (see Figure 16)		13 4 6		nC nC nC
Opso.	R_{G}	Gate input resistance	f=1MHz Gate DC Bias = 0 Test signal level = 20mV Open drain		3		Ω
	1 Pulsadir	oulse duration=300us, duty cycle 1	1.5%				

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

^{2.} $C_{\rm oss~eq.}$ is defined as a constant equivalent capacitance giving the same charging time as $C_{\rm oss}$ when $V_{\rm DS}$ increases from 0 to 80% $V_{\rm DSS}$

Table 6. Switching times

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =250 V, I_{D} =2.5A, R_{G} =4.7 Ω , V_{GS} =10V (see Figure 15)		16 8		ns ns
t _{r(Voff)} t _f t _C	Off-voltage rise time Fall time Cross-over time	V_{DD} =400 V, I_{D} =5A, R_{G} =4.7 Ω , V_{GS} =10V (see Figure 15)		14 6 13		ns ns ns

Table 7. Source drain diode

-	Parameter	Test conditions	Min	Тур	Max	Unit
I _{SD} I _{SDM}	Source-drain current Source-drain current (pulsed)		~ <u>@</u>	N	8 32	A A
V _{SD}	Forward on voltage	I _{SD} =10A, V _{GS} =0			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =5A, di/dt = 100A/ μ s, V_{DD} =100 V, Tj=25°C (see Figure 20)		185 1.1 11.5		ns μC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} =5A, di/dt = 100A/ μ s, V_{DD} =100 V, Tj=150°C (see Figure 20)		270 1.6 12		ns μC A
	.151					
*eP	Reverse recovery current					

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2.1 Electrical characteristics (curves)

Figure 1. Safe operating area for TO-220 Figure 2. Thermal impedance for TO-220

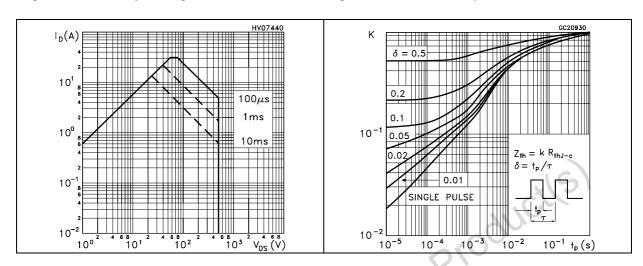


Figure 3. Safe operating area for TO-220FP Figure 4. Safe operating area for TO-220FP

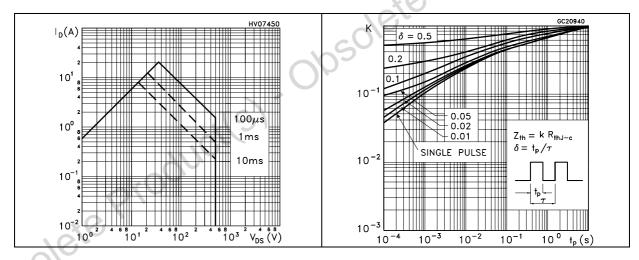


Figure 5. Output characteristics

Figure 6. Transfer characteristics

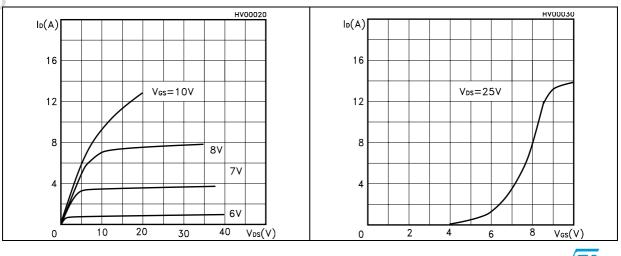


Figure 7. Transconductance

Figure 8. Static drain-source on resistance

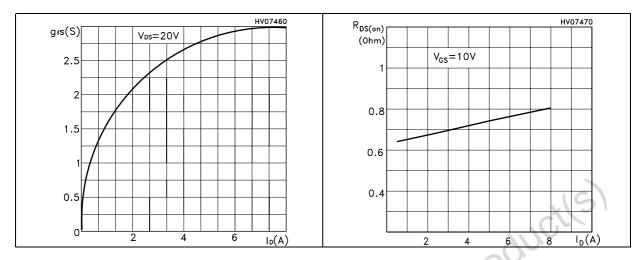


Figure 9. Gate charge vs gate-source voltage Figure 10. Capacitance variations

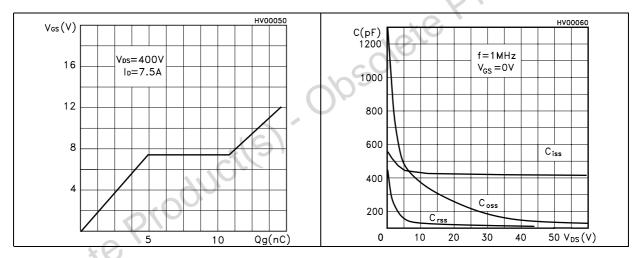


Figure 11. Normalized gate threshold voltage Figure 12. Normalized on resistance vs vs temperature temperature

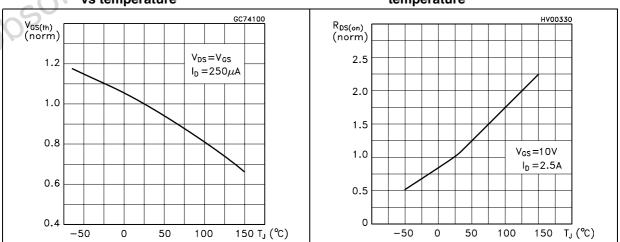
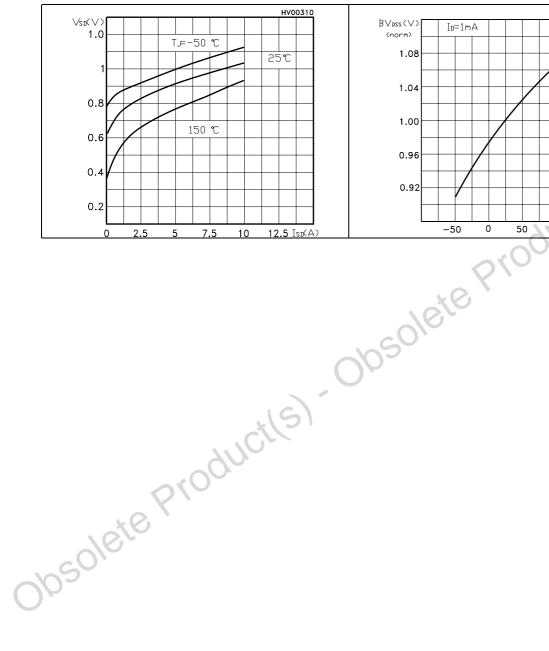
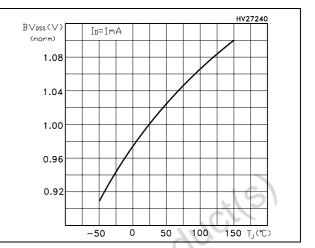


Figure 13. Source-drain diode forward characteristics

Figure 14. Normalized B_{VDSS} vs temperature





3 Test circuit

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

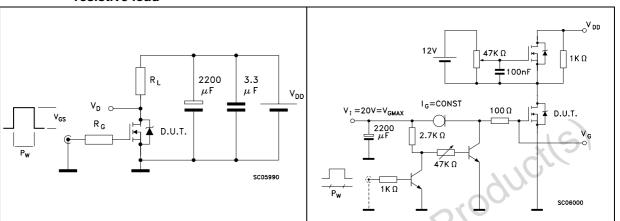


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped Inductive load test circuit

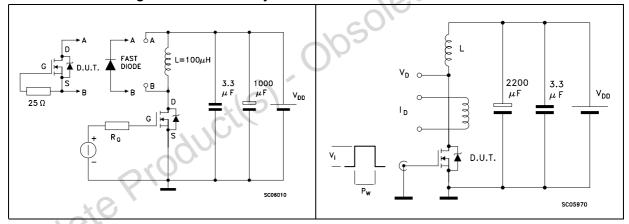
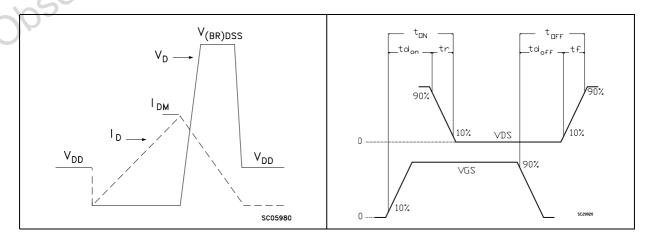


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



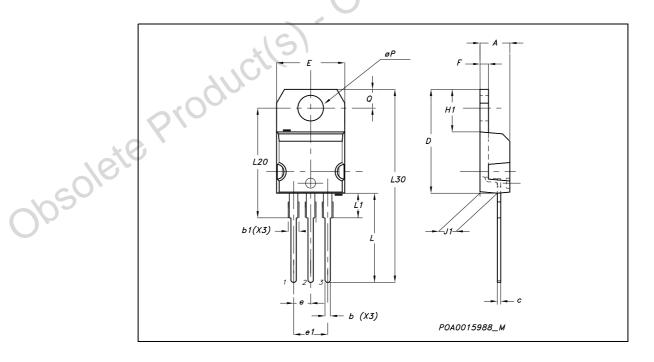
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s).

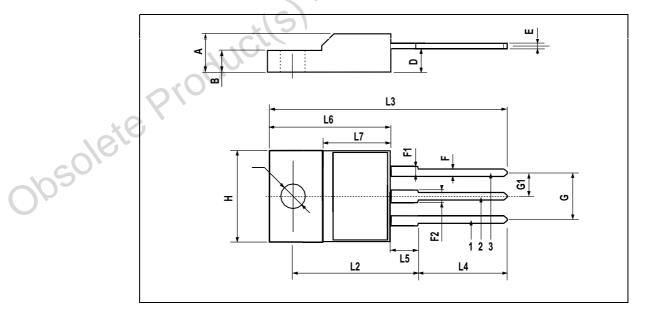
TO-220 MECHANICAL DATA

DIM.		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094	70	0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40		760	0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



TO-220FP MECHANICAL DATA

DIM.		mm.			inch	
DIWI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
Е	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045	1	0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094	400	0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	.0385		0.417
L5	2.9		3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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5 Revision history

Table 8. Revision history

	Date	Revision	Changes
	09-Sep-2004	4	Title changed
	11-Aug-2006	5	New template
	22-Sep-2006	6	Some value change in Table 4: On/off states
	18-Oct-2006	7	Updated Note 3 on page 3
Obsole	ie Prod	Juct(S)	Updated Note 3 on page 3

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